

ISL8117DEMO4Z

User's Manual: Demonstration Board

Industrial Analog and Power

ISL8117DEMO4Z

Demonstration Board

UG133
Rev.0.00
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1. Overview

The ISL8117DEMO4Z demonstration board (shown in [Figure 4](#)) features the [ISL8117](#). The ISL8117 is a 60V high voltage synchronous buck controller that offers external soft-start, independent enable functions, and integrates UV/OV/OC/OT protection. Its current mode control architecture and internal compensation network keep peripheral component count minimal. Programmable switching frequency ranging from 100kHz to 2MHz helps to optimize inductor size while the strong gate driver delivers up to 30A for the buck output.

1.1 Key Features

- Small, compact design
- Wide input range: 6V to 60V
- High light-load efficiency in pulse skipping DEM operation
- Programmable soft-start
- Optional DEM/CCM operation
- Supports prebias output with SR soft-start
- External frequency sync
- PGOOD indicator
- OCP, OVP, OTP, and UVP protection

1.2 Specifications

The ISL8117DEMO4Z demonstration board is designed for high current applications. The current rating of the ISL8117DEMO4Z is limited by the FETs and inductor selected. The electrical ratings of the ISL8117DEMO4Z are shown in [Table 1](#).

Table 1. Electrical Ratings

Parameter	Rating
Input Voltage	6V to 60V
Switching Frequency	300kHz
Output Voltage	5V
Output Current	6A
OCP Set Point	Minimum 8A at ambient room temperature

1.3 Ordering Information

Part Number	Description
ISL8117DEMO4Z	High voltage PWM step-down synchronous buck controller

1.4 Related Literature

- For a full list of related documents, visit our website
- [ISL8117](#) product page

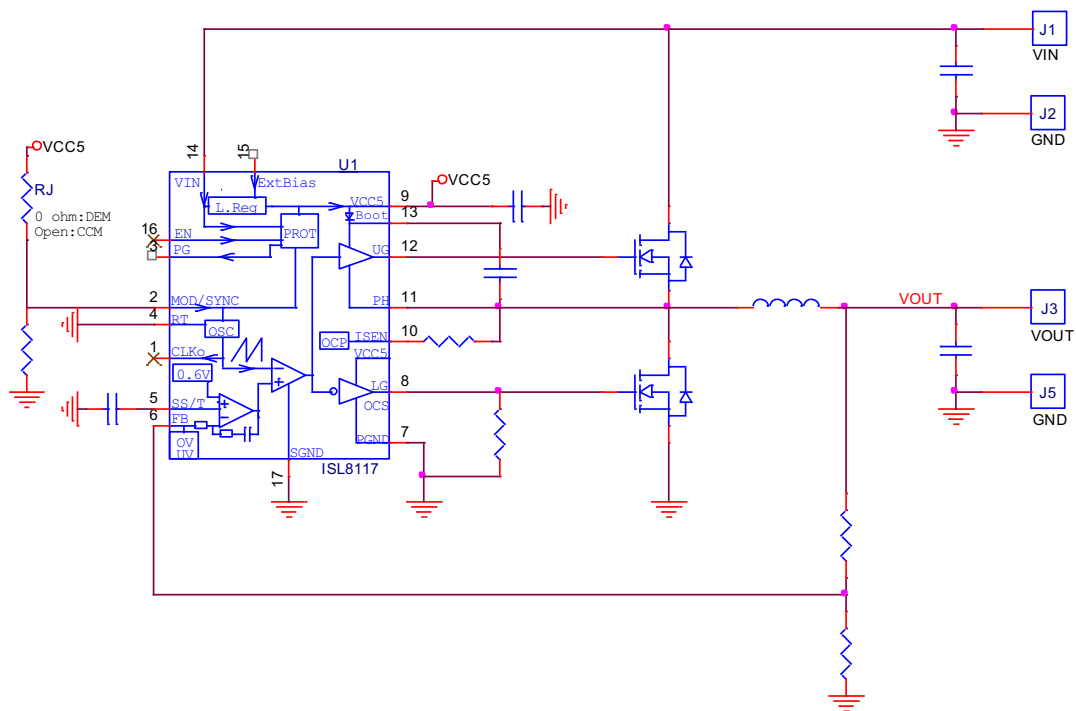


Figure 1. ISL8117DEMO4Z Block Diagram

2. Functional Description

The ISL8117DEMO4Z features a compact design with high efficiency and high power density.

As shown in [Figure 3 on page 7](#), 6V to 60V V_{IN} is supplied to J1 (+) and J2 (-). The regulated 5V output on J3 (+) and J5 (-) can supply up to 6A to the load.

2.1 Recommended Testing Equipment

The following materials are recommended to perform testing:

- 0V to 60V power supply with at least 10A source current capability
- Electronic loads capable of sinking current up to 10A
- Digital Multimeters (DMMs)
- 100MHz quad-trace oscilloscope

2.2 Quick Test Guide

- (1) Ensure that the circuit is correctly connected to the supply and electronic loads before to applying any power. Refer to [Figure 3 on page 7](#) for proper setup.
- (2) Turn on the power supply.
- (3) Adjust the input voltage V_{IN} within the specified range and observe the output voltage. The output voltage variation should be within 3%.
- (4) Adjust the load current within the specified range and observe the output voltage. The output voltage variation should be within 3%.
- (5) Use an oscilloscope to observe output voltage ripple and phase node ringing. For accurate measurement, refer to [Figure 2](#) for proper test setup.

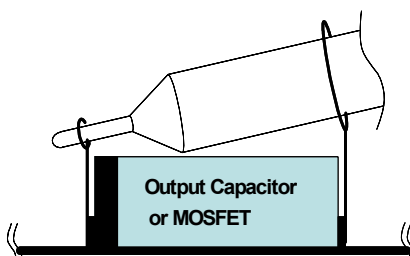


Figure 2. Proper Probe Setup to Measure Output Ripple and Phase Node Ringing

2.3 Operating Range

The input voltage range is from 6V to 60V for an output voltage of 5V. The rated load current is 6A with the OCP point set at a minimum 8A at room temperature ambient conditions.

The ISL8117 has an operating temperature range of -40°C to +125°C. Note that airflow is needed.

2.4 Evaluating the Other Output Voltages

The ISL8117DEMO4Z output is preset to 5V, however, the output can be adjusted from 1.8V to 5V. The output voltage programming resistor, R_2 , will depend on the desired output voltage of the regulator and the value of the feedback resistor R_1 , as shown in [Equation 1](#).

$$R_2 = R_1 \left(\frac{0.6}{V_{OUT} - 0.6} \right) \quad (\text{EQ. 1})$$

[Table 2](#) shows the component selection that should be used for the respective V_{OUT} of 1.8V, 3.3V, and 5V.

Table 2. External Component Selection

V_{OUT} (V)	R_2 (k Ω)
1.8	24.9
3.3	11
5	6.8

Note:

1. If $V_{OUT} < 3.3V$, the minimal V_{IN} is approximately 4.5V for full load. If $V_{OUT} = 5V$, the minimal V_{IN} is approximately 6V for full load.
2. Unless $V_O = 5V$, R_{11} should be removed.

3. PCB Layout Guidelines

Careful attention to layout requirements is necessary for successful implementation of an ISL8117-based DC/DC converter. The ISL8117 switches at a very high frequency and therefore the switching times are very short. At these switching frequencies, even the shortest trace has significant impedance. Also, the peak gate drive current rises significantly in an extremely short time. Transition speed of the current from one device to another causes voltage spikes across the interconnecting impedances and parasitic circuit elements. These voltage spikes can degrade efficiency, generate EMI, and increase device overvoltage stress and ringing. Careful component selection and proper PC board layout minimizes the magnitude of these voltage spikes.

There are three sets of critical components in a DC/DC converter using the ISL8117:

- The controller
- The switching power components
- The small signal components

The switching power components are the most critical from a layout point of view because they switch a large amount of energy, which tends to generate a large amount of noise. The critical small signal components are those connected to sensitive nodes or those supplying critical bias currents. A multilayer printed circuit board is recommended.

3.1 Layout Considerations

- (1) The input capacitors, upper FET, lower FET, inductor, and output capacitor should be placed first. Isolate these power components on dedicated areas of the board with their ground terminals adjacent to one another. Place the input high frequency decoupling ceramic capacitors very close to the MOSFETs.
- (2) If signal components and the IC are placed in a separate area from the power train, it is recommended to use full ground planes in the internal layers with shared SGND and PGND to simplify the layout design. Otherwise, use separate ground planes for power ground and small signal ground. Connect the SGND and PGND together close to the IC. DO NOT connect them together anywhere else.
- (3) The loop formed by the input capacitor, the top FET, and the bottom FET must be kept as small as possible.
- (4) Ensure the current paths from the input capacitor to the MOSFET, to the output inductor, and the output capacitor are as short as possible with maximum allowable trace widths.
- (5) Place the PWM controller IC close to the lower FET. The LGATE connection should be short and wide. The IC can be best placed over a quiet ground area. Avoid switching ground loop currents in this area.
- (6) Place the VCC5V bypass capacitor very close to the VCC5V pin of the IC and connect its ground to the PGND plane.
- (7) Place the gate drive components (optional BOOT diode and BOOT capacitors) together near the controller IC.
- (8) The output capacitors should be placed as close to the load as possible. Use short wide copper regions to connect the output capacitors to load to avoid inductance and resistances.
- (9) Use copper filled polygons or wide but short trace to connect the junction of the upper FET, lower FET, and output inductor. Also keep the PHASE node connection to the IC short. DO NOT unnecessarily oversize the copper islands for the PHASE node. Because the phase nodes are subjected to very high dv/dt voltages, the stray capacitor formed between these islands and the surrounding circuitry will tend to couple switching noise.
- (10) Route all high-speed switching nodes away from the control circuitry.
- (11) Create a separate small analog ground plane near the IC. Connect the SGND pin to this plane. All small signal grounding paths including feedback resistors, current limit setting resistor, soft-starting capacitor, and EN pull-down resistor should be connected to this SGND plane.
- (12) Separate the current sensing trace from the PHASE node connection.
- (13) Ensure the feedback connection to the output capacitor is short and direct.

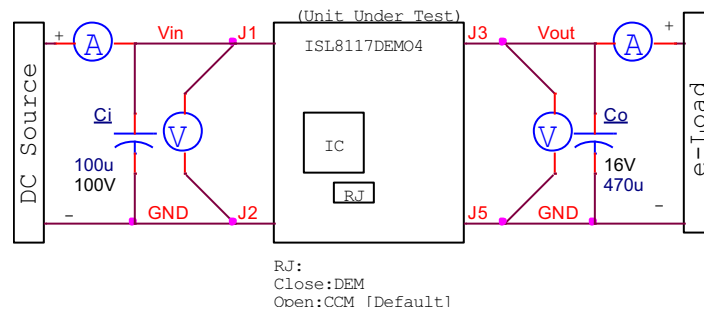


Figure 3. Proper Test Setup

3.2 ISL8117DEMO4Z Demonstration Board

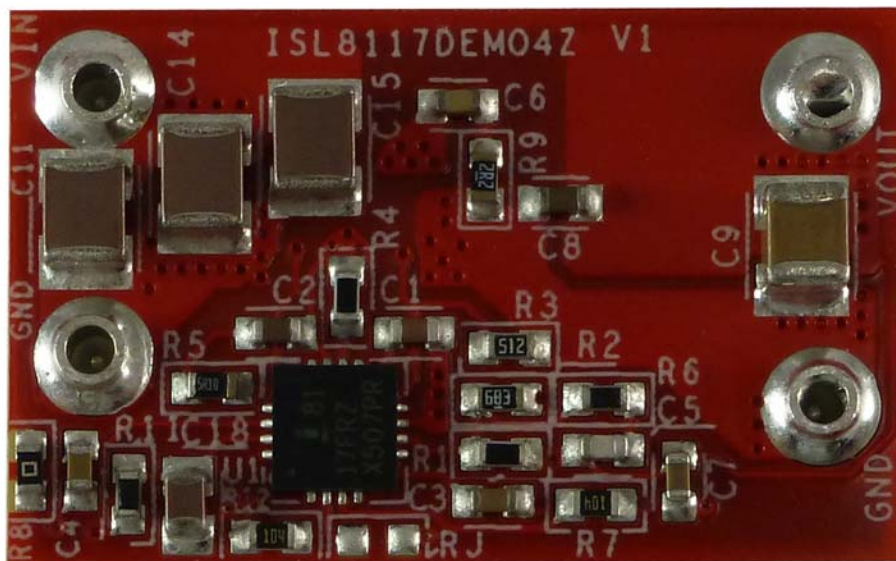


Figure 4. ISL8117DEMO4Z Top Side



Figure 5. ISL8117DEMO4Z Bottom Side

Figure 6. ISL8117DEMO4Z Schematic

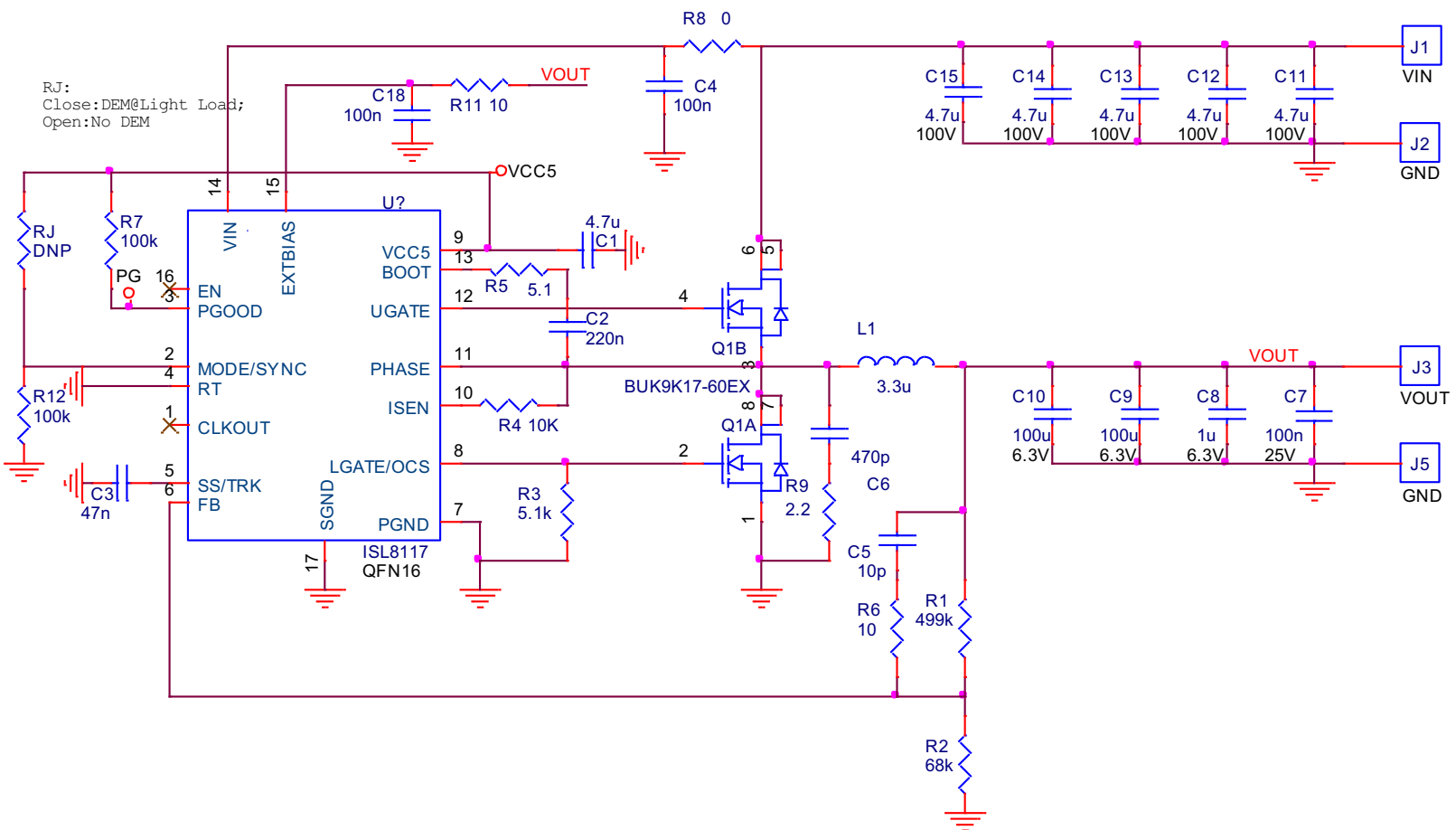


Figure 6. ISL8117DEMO4Z Schematic

3.4 ISL8117DEMO4Z Bill of Materials

Manufacturer Part	Qty	Reference Designator	Description	Manufacturer
C0603COG500-100KDE	1	C5	CAP, SMD, 0603, 10pF, 50V, 10%, NP0, ROHS	VENKEL
C0603X7R101-104KNE	1	C4	CAP, SMD, 0603, 0.1µF, 100V, 10%, X7R, ROHS	VENKEL
GRM188R71E104KA01D	1	C7	CAP, SMD, 0603, 0.1µF, 25V, 10%, X7R, ROHS	MURATA
ECJ1VB0J105K	1	C8	CAP, SMD, 0603, 1µF, 6.3V, 10%, X5R, ROHS	PANASONIC
C1608X7R1E224K	1	C2	CAP, SMD, 0603, 0.22µF, 25V, 10%, X7R, ROHS	TDK
VJ0603Y471KXBA	1	C6	CAP, SMD, 0603, 470pF, 100V, 10%, X7R, ROHS	VISHAY
GRM188R71E473KA01D	1	C3	CAP, SMD, 0603, 0.047µF, 25V, 10%, X7R, ROHS	MURATA
CR0603-16W-4701FT	1	C1	CAP, SMD, 0603, 4.7µF, 10V, 10%, X5R, ROHS	VENKEL
C2012X7R2A104K	1	C18	CAP, SMD, 0805, 0.1µF, 100V, 10%, X7R, ROHS	TDK
12106D107KAT2A	2	C9, C10	CAP, SMD, 1210, 100µF, 6.3V, 10%, X5R, ROHS	AVX
CGA6M3X7S2A475K200AB	5	C11, C12, C13, C14, C15	CAP, SMD, 1210, 4.7µF, 100V, 10%, X7S, ROHS	TDK
7443340330	1	L1	COIL-PWR INDUCTOR, SMD, 8.4x7.9, 3.3µH, 20%, 14A, ROHS	Würth Electronics
1514-2	4	J1, J2, J3, J5	CONN-TURRET, TERMINAL POST, TH, ROHS	KEYSTONE
ISL8117FRZ	1	U1	IC-55V SWITCHING CONTROLLER, 16P, QFN, ROHS	INTERSIL
BUK9K17-60EX	1	Q1	TRANSIST-MOS, DUAL N-CHANNEL, SMD, 8P, 56LPAK, 60V, 26A, ROHS	NXP SEMICONDUCTOR
RK73H1JT10R0F	2	R6, R11	RES, SMD, 0603, 10Ω, 1/10W, 1%, TF, ROHS	KOA
ERJ-3RQF2R2V	1	R9	RES, SMD, 0603, 2.2Ω, 1/10W, 1%, TF, ROHS	PANASONIC
CR0603-10W-05R1FT	1	R5	RES, SMD, 0603, 5.1Ω, 1/10W, 1%, TF, ROHS	VENKEL
CR0603-10W-000T	1	R8	RES, SMD, 0603, 0Ω, 1/10W, TF, ROHS	VENKEL
CR0603-10W-1002FT	1	R4	RES, SMD, 0603, 10k, 1/10W, 1%, TF, ROHS	VENKEL
CR0603-10W-1003FT	2	R7, R12	RES, SMD, 0603, 100k, 1/10W, 1%, TF, ROHS	VENKEL
ERJ-3EKF4993V	1	R1	RES, SMD, 0603, 499k, 1/10W, 1%, TF, ROHS	PANASONIC
CR0603-10W-5101FT	1	R3	RES, SMD, 0603, 5.1k, 1/10W, 1%, TF, ROHS	VENKEL
RC0603FR-0768KL	1	R2	RES, SMD, 0603, 68k, 1/10W, 1%, TF, ROHS	YAGEO
	0	RJ	RES, SMD, 0603, DNP-PLACE HOLDER, ROHS	

3.5 ISL8117DEMO4Z PCB Layout

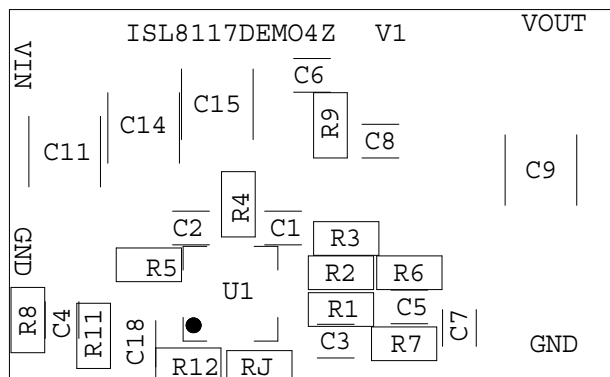


Figure 7. Assembly Top

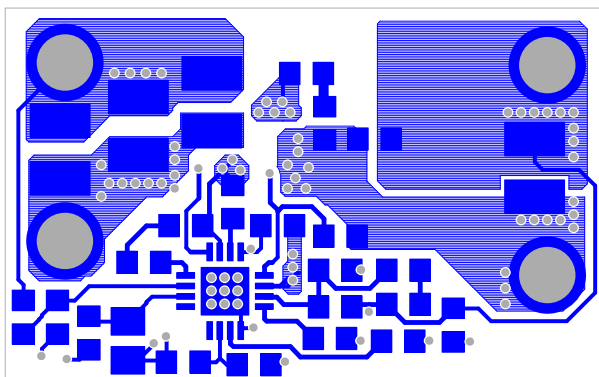


Figure 8. Top Layer

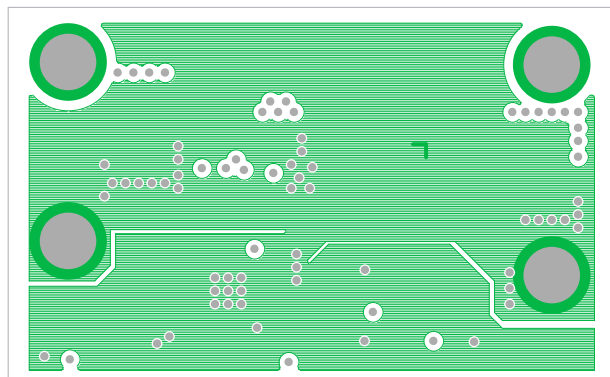


Figure 9. Second Layer (Solid Ground)

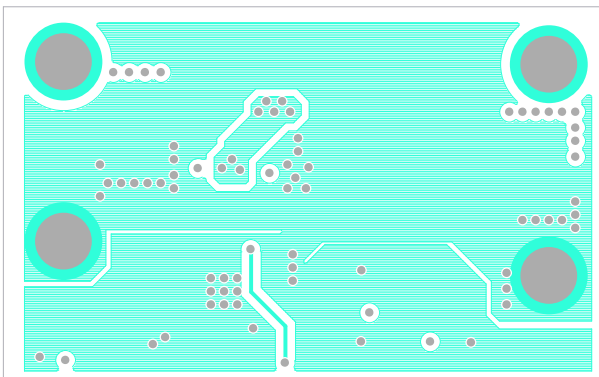


Figure 10. Third Layer



Figure 11. Bottom Layer

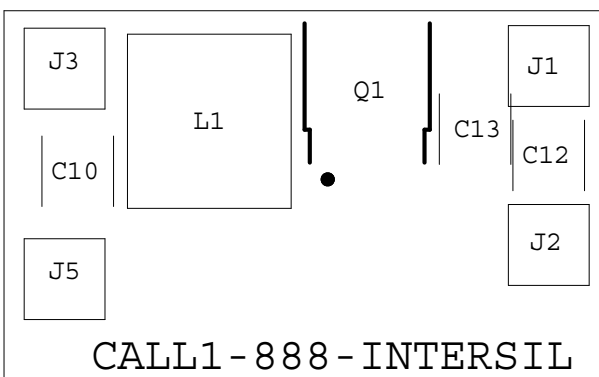


Figure 12. Assembly Bottom

3.6 Typical Demonstration Board Performance Curves

$V_{IN} = 24V$, $V_{OUT} = 5V$, unless otherwise noted.

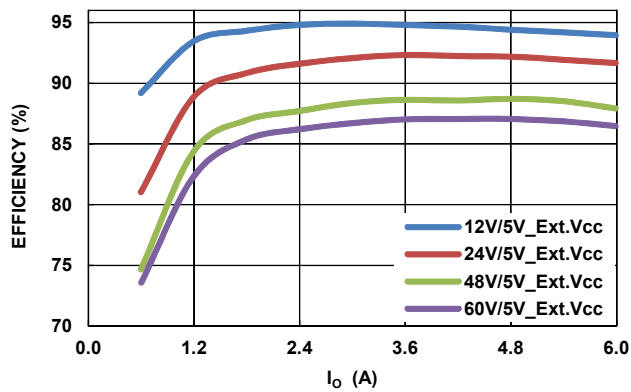


Figure 13. CCM Efficiency

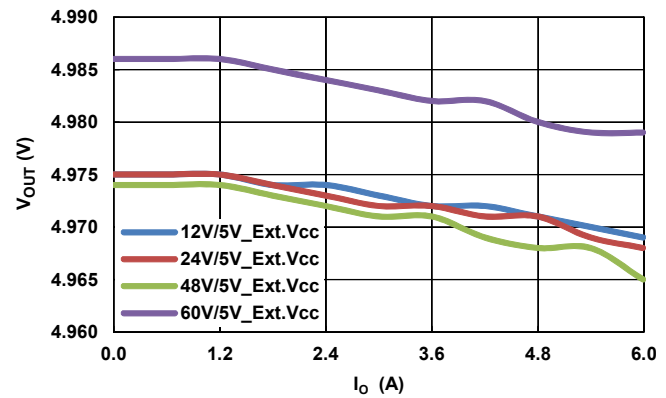


Figure 14. CCM Load Regulation

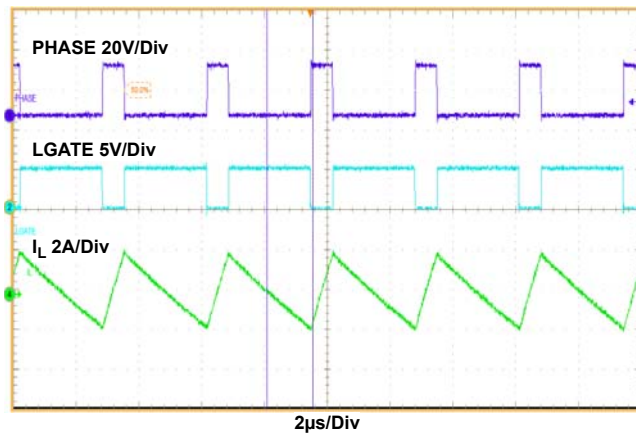


Figure 15. PHASE, LGATE and Inductor Current Waveforms, $I_O = 0A$

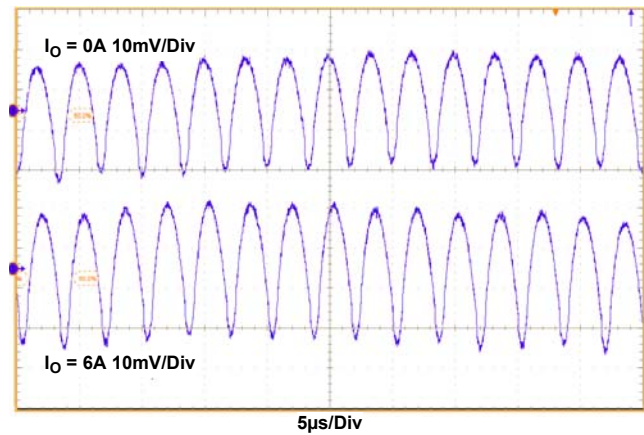


Figure 16. Output Ripple, Mode = CCM

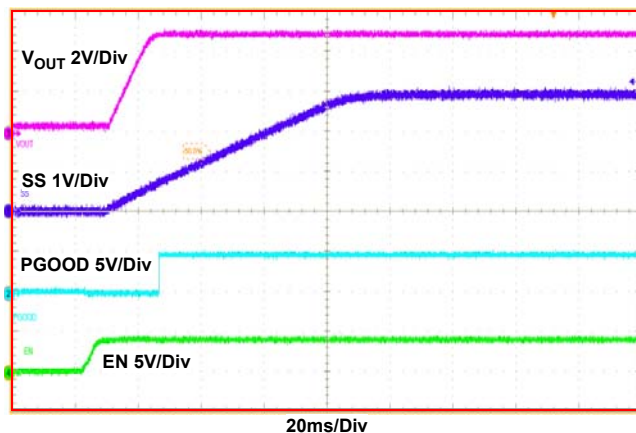


Figure 17. CCM Start-Up Waveforms: V_{OUT} , SS, PGOOD, EN, $I_O = 0A$

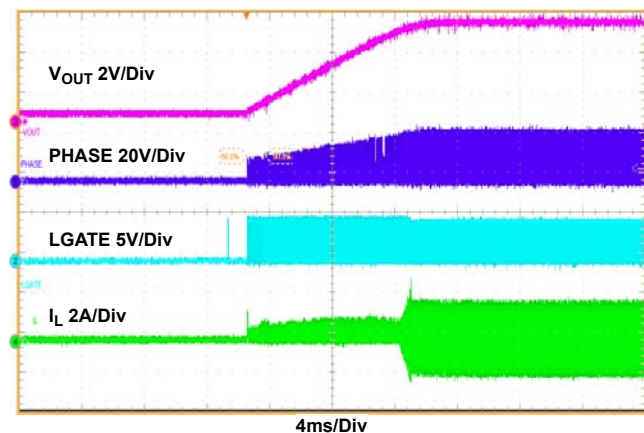


Figure 18. CCM Start-Up Waveforms: V_{OUT} , PHASE, LGATE, I_L , $I_O = 0A$

$V_{IN} = 24V$, $V_{OUT} = 5V$, unless otherwise noted. (Continued)

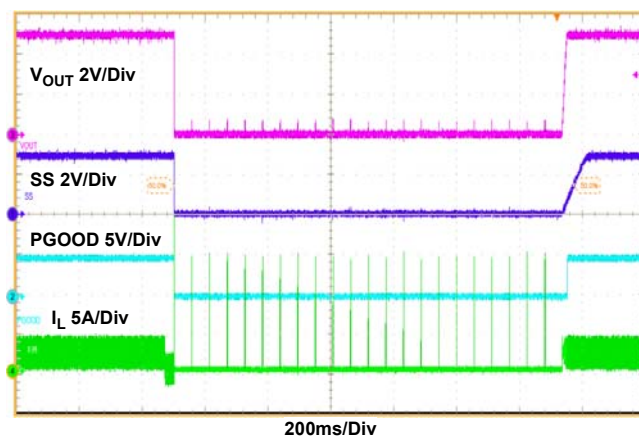


Figure 19. Short-Circuit Waveforms

4. Revision History

Rev.	Date	Description
0.00	Aug 3, 2017	Initial release

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Renesas Electronics America Inc.
1001 Murphy Ranch Road, Milpitas, CA 95035, U.S.A.
Tel: +1-408-432-8888, Fax: +1-408-434-5351

Renesas Electronics Canada Limited
9251 Yonge Street, Suite 8309 Richmond Hill, Ontario Canada L4C 9T3
Tel: +1-905-237-2004

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-651-700, Fax: +44-1628-651-804

Renesas Electronics Europe GmbH
Arcadiastrasse 10, 40472 Düsseldorf, Germany
Tel: +49-211-6503-0, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
Room 1709 Quantum Plaza, No.27 ZhichunLu, Haidian District, Beijing, 100191 P. R. China
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 301, Tower A, Central Towers, 555 Langao Road, Putuo District, Shanghai, 200333 P. R. China
Tel: +86-21-2226-0888, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited
Unit 1601-1611, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2265-6688, Fax: +852-2886-9022

Renesas Electronics Taiwan Co., Ltd.
13F, No. 363, Fu Shing North Road, Taipei 10543, Taiwan
Tel: +886-2-8175-9600, Fax: +886-2-8175-9670

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80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre, Singapore 339949
Tel: +65-6213-0200, Fax: +65-6213-0300

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Renesas Electronics India Pvt. Ltd.
No.777C, 100 Feet Road, HAL 2nd Stage, Indiranagar, Bangalore 560 038, India
Tel: +91-80-67208700, Fax: +91-80-67208777

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ISL8117DEMO4Z



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